IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on-state voltage and minimal switching loss. The IGBT is well suited for resonant or soft switching applications. Incorporated into the device is a rugged co-packaged free wheeling diode with a low forward voltage.

Features

- Low Saturation Voltage using Trench with Field Stop Technology
- Low Switching Loss Reduces System Power Dissipation
- Optimized for Low Case Temperature in IH Cooker Application
- Low Gate Charge
- These are Pb–Free Devices

Typical Applications

- Inductive Heating
- Consumer Appliances
- Soft Switching

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	I _c	60 30	A
Pulsed collector current, T _{pulse} limited by T _{Jmax}	I _{CM}	320	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	I _F	60 30	A
Diode pulsed current, T _{pulse} limited by T _{Jmax}	I _{FM}	320	A
Gate-emitter voltage	V_{GE}	±20	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	260 104	W
Operating junction temperature range	TJ	–55 to +150	°C
Storage temperature range	T _{stg}	–55 to +150	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

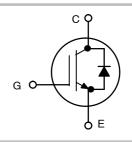
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

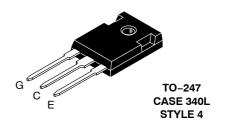


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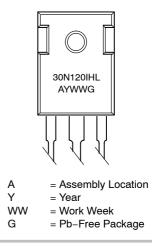
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30 A, 1200 V V_{CEsat} = 1.75 V E_{off} = 1.0 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB30N120IHLWG	TO-247 (Pb-Free)	30 Units / Rail

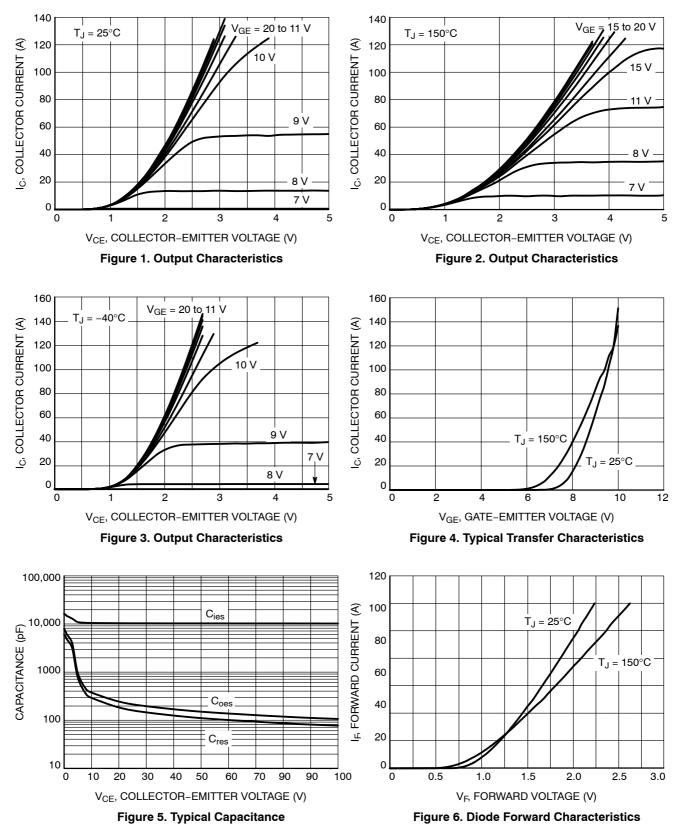
THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.48	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.5	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

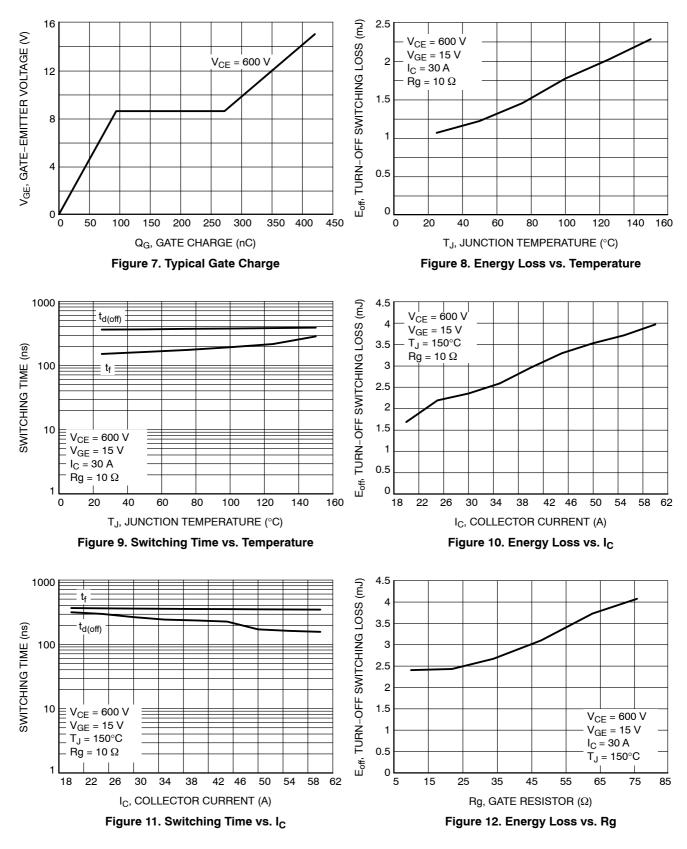
ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•	•				
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	1200	-	-	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 30 A V _{GE} = 15 V, I _C = 30 A, T _J = 150°C	V _{CEsat}	-	1.75 2.1	2.2 _	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 250 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V_{GE} = 0 V, V_{CE} = 1200 V V_{GE} = 0 V, V_{CE} = 1200 V, T_{J} = 150°C	I _{CES}			0.5 2.0	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V, V_{CE} = 0 V	I _{GES}	_	-	200	nA
DYNAMIC CHARACTERISTIC	•					
Input capacitance		C _{ies}	-	10,400	-	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	-	245	-	
Reverse transfer capacitance		C _{res}	-	185	-	
Gate charge total		Qg		420		nC
Gate to emitter charge	V_{CE} = 600 V, I _C = 30 A, V _{GE} = 15 V	Q _{ge}		94		
Gate to collector charge		Q _{gc}		178		
SWITCHING CHARACTERISTIC, INDUCT	IVE LOAD					
Turn-off delay time	$T_J = 25^{\circ}C$	t _{d(off)}		360		ns
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 30 \text{ A}$ $\text{R}_{a} = 10 \Omega$	t _f		150		
Turn-off switching loss	V _{GE} = 0 V/ 15V	E _{off}		1.0		mJ
Turn-off delay time	T _J = 125°C	t _{d(off)}		380		ns
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 30 \text{ A}$ $R_{a} = 10 \Omega$	t _f		216		
Turn–off switching loss	V _{GE} = 0 V/ 15V	E _{off}		2.0		mJ
DIODE CHARACTERISTIC						
Forward voltage	V _{GE} = 0 V, I _F = 30 A V _{GE} = 0 V, I _F = 30 A, T _J = 150°C	V _F		1.5 1.7	1.7	V

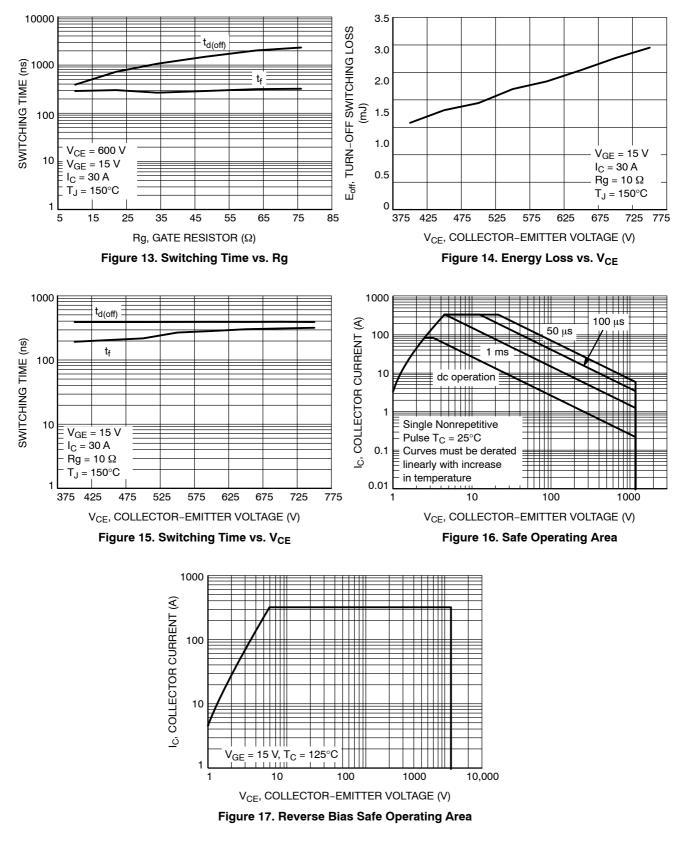




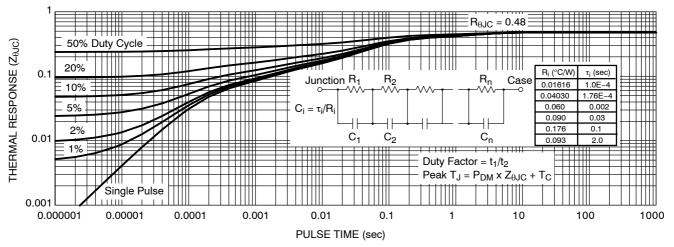
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





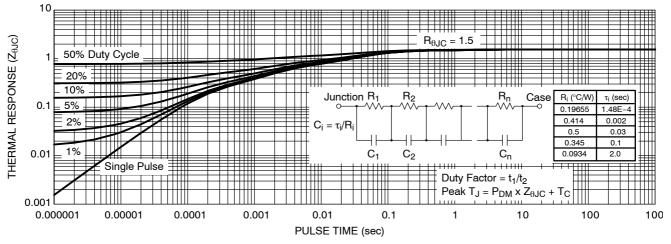


Figure 19. Diode Transient Thermal Impedance

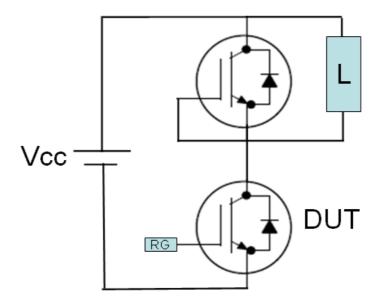


Figure 20. Test Circuit for Switching Characteristics

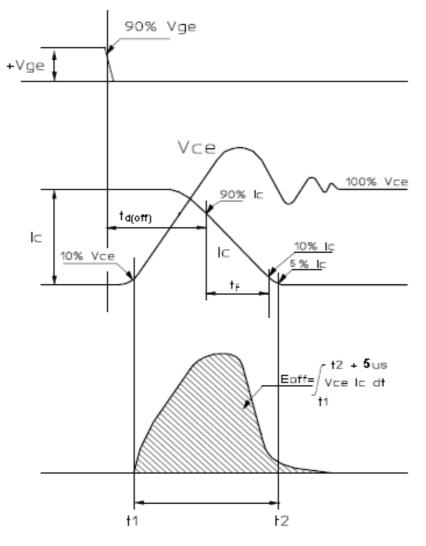


Figure 21. Definition of Turn Off Waveform

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TO-247 CASE 340L ISSUE G G SCALE 1:1 Т В EATING -Ν Α 7 . ർറ ∲Ø0.63 (0.025)@|T|B@ Р Ý 2X F G ·H ЗХ D ♦ 0.25 (0.010) W Y AS

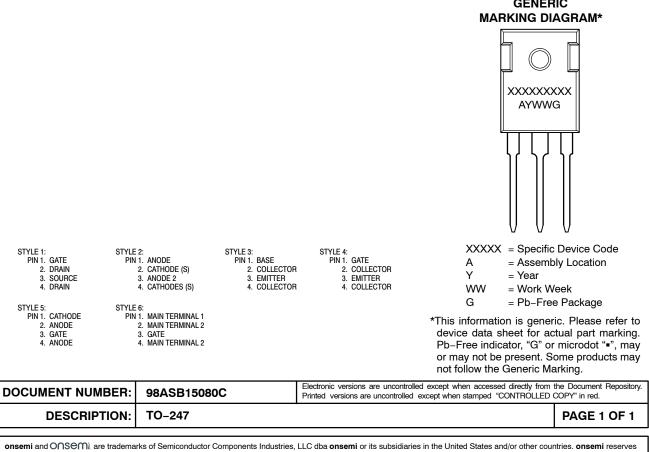
DATE 06 OCT 2021

NOTES

- DIMENSIONING AND TOLERANCING PER ASME 1. Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER

	MILLIMETERS		INC	HES
DIM	MIN.	MAX.	MIN.	MAX.
A	20.32	21.08	0.800	0.830
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
E	1.90	2.60	0.075	0.102
F	1.65	2.13	0.065	0.084
G	5.45 BSC		0.215 BSC	
н	1.50	2.49	0.059	0.098
J	0.40	0.80	0.016	0.031
к	19.81	20.83	0.780	0.820
L	5.40	6.20	0.212	0.244
N	4.32	5.49	0.170	0.216
Р		4.50		0.177
Q	3.55	3.65	0.140	0.144
U	6.15 BSC		0.242 BSC	
W	2.87	3.12	0.113	0.123

GENERIC



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